



#### 65V NPN MATCHED PAIR SMALL SIGNAL TRANSISTOR IN SOT363

Flammability Classification Rating 94V-0

Weight: 0.006 grams (Approximate)

Moisture Sensitivity: Level 1 per J-STD-020

Case Material: Molded Plastic, "Green" Molding Compound. UL

Terminals: Finish — Matte Tin Finish. Solderable per MIL-STD-

**Mechanical Data** 

Case: SOT363

202, Method 208 @3)

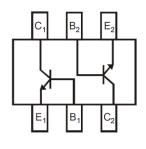
### Features

- Ultra-Small Surface Mount Package
- Current Gain Matching
- Base-Emitter Voltage Matching
- Ideally Suited for Automated Insertion
- For Switching and AF Amplifier Application
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

SOT363



Top View



Device Schematic Top View

### Ordering Information (Note 4)

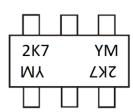
Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity Per Reel	
BCM846BS-7	AEC-Q101	2K7	7	8	3,000	
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.						

No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



2K7 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: F = 2018) M = Month (ex: 9 = September)

Date Code Key

Year	2018	201	9	2020	20	)21	2022	2	2023	2024		2025
Code	F	G		Н			J		K	L		М
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	80	V
Collector-Emitter Voltage	V <sub>CEO</sub>	65	V
Emitter-Base Voltage	V <sub>EBO</sub>	6	V
Collector Current	lc	100	mA
Peak Collector Current	I <sub>CM</sub>	200	mA
Peak Base Current	I <sub>BM</sub>	200	mA

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	200	mW
Thermal Resistance, Junction to Ambient (Note 6)	$R_{ heta}$ JA	625	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

## ESD Ratings (Note 6)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge – Human Body Model	ESD HBM	4,000	V	ЗA
Electrostatic Discharge – Machine Model	ESD MM	400	V	С

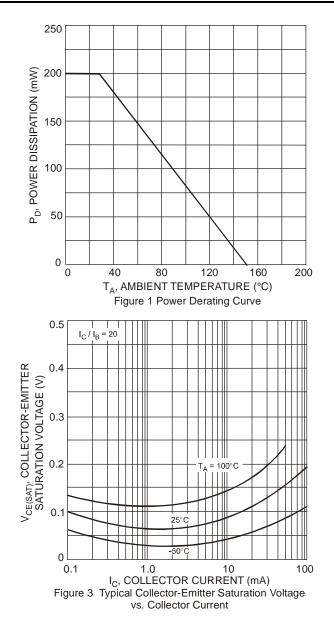
#### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

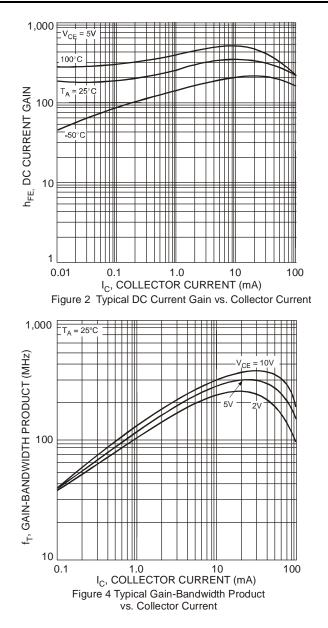
Characteristic (Note 7)	Symbol	Min	Тур	Мах	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	80	_	_	V	$I_{\rm C} = 100 \mu A, I_{\rm B} = 0$
Collector-Emitter Breakdown Voltage		65			V	$I_{\rm C} = 10 {\rm mA}, I_{\rm B} = 0$
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	6	_	_	V	$I_E = 100 \mu A, I_C = 0$
DC Current Gain	h <sub>FE</sub>	200	_	450	—	$V_{CE} = 5V, I_{C} = 2mA$
DC Current Gain Matching	h <sub>FE1</sub> /h <sub>FE2</sub>	0.9	1	1.1	-	$V_{CE} = 5V, I_C = 2mA$
Collector-Emitter Saturation Voltage	V <sub>CE(SAT)</sub>		—	100 400	mV	$I_C = 10mA$ , $I_B = 0.5mA$ $I_C = 100mA$ , $I_B = 5mA$
Base-Emitter Saturation Voltage	N/		755	_	mV	$I_{C} = 10mA, I_{B} = 0.5mA$
Dase-Emilier Saluration Voltage	V <sub>BE(SAT)</sub>		905	_	mV	$I_{C} = 100 \text{mA}, I_{B} = 5 \text{mA}$
Base-Emitter Voltage	V <sub>BE(ON)</sub>	610	665	710	mV	$V_{CE} = 5V, I_{C} = 2mA$
Base-Emitter Voltage Matching	V <sub>BE1(ON)</sub> - V <sub>BE2(ON)</sub>	-2	—	2	mV	$V_{CE} = 5V, I_C = 2mA$
Collector-Cutoff Current	1		_	15	nA	$V_{CB} = 40V$
	I <sub>CBO</sub>	_		5	μA	V <sub>CB</sub> = 40V, T <sub>A</sub> = +125°C
Emitter-Cutoff Current	I <sub>EBO</sub>	_		20	nA	$V_{EB} = 5V, I_{C} = 0$
Gain Bandwidth Product	f⊤	100	_	_	MHz	$V_{CE} = 5V$ , $I_C = 10mA$ , f = 100MHz
Collector-Base Capacitance	C <sub>CBO</sub>		2	3	pF	$V_{CB} = 10V, f = 1MHz$
Emitter-Base Capacitance	CEBO	_	11	_	pF	V <sub>EB</sub> = 0.5V, f = 1MHz

Notes: 5. For a device mounted with the collector lead on minimum recommended pad layout 1oz copper that is on a single-sided 1.6mm FR-4 PCB; device is measured under still air conditions whilst operating in a steady-state.
Refer to JEDEC specification JESD22-A114 and JESD22-A115.
Short duration pulse test used to minimize self-heating effect.



# Typical Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)





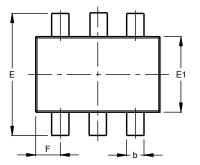


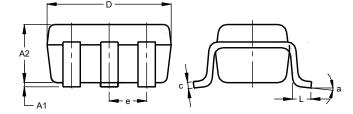
## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363

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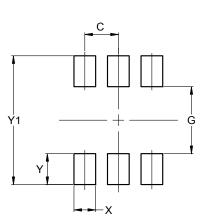




SOT363								
Dim	Min	Max	Тур					
A1	0.00	0.10	0.05					
A2	0.90	1.00	0.95					
b	0.10	0.30	0.25					
c	0.10	0.22	0.11					
D	1.80	2.20	2.15					
Е	2.00	2.20	2.10					
E1	1.15	1.35	1.30					
е	C	).650 E	SC					
F	0.40	0.45	0.425					
L	0.25	0.40	0.30					
а	0°	8°						
All I	All Dimensions in mm							

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.650
G	1.300
Х	0.420
Y	0.600
Y1	2.500

BCM846BS	
Document number: DS41262 Rev. 1 - 2	



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